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THIS SPEC IS OBSOLETE

Spec No: 001-59002

Spec Title: CY23FS04-3, FAILSAFE(TM) 2.5 V/3.3 V ZERO DELAY BUFFER

Sunset Owner: Anuj Chakrapan (AJU)i

Replaced By: None

CY23FS04-3

Failsafe™ 2.5 V/3.3 V Zero Delay Buffer

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Features

- Internal digital controlled crystal oscillator (DCXO) for continuous glitch-free operation
- Zero input-output propagation delay
- Low-jitter (35 ps max RMS) outputs
- Low output-to-output skew (200 ps max)
- 4.17 MHz to 166.7 MHz reference input
- Supports industry standard input crystals
- 166.7 MHz outputs
- 5 V-tolerant inputs
- Phase-locked loop (PLL) bypass mode
- Dual reference inputs
- 16-pin thin shrunk small outline package (TSSOP)
- 2.5 V or 3.3 V output power supplies
- 3.3 V core power supply
- Industrial temperature range

Functional Description

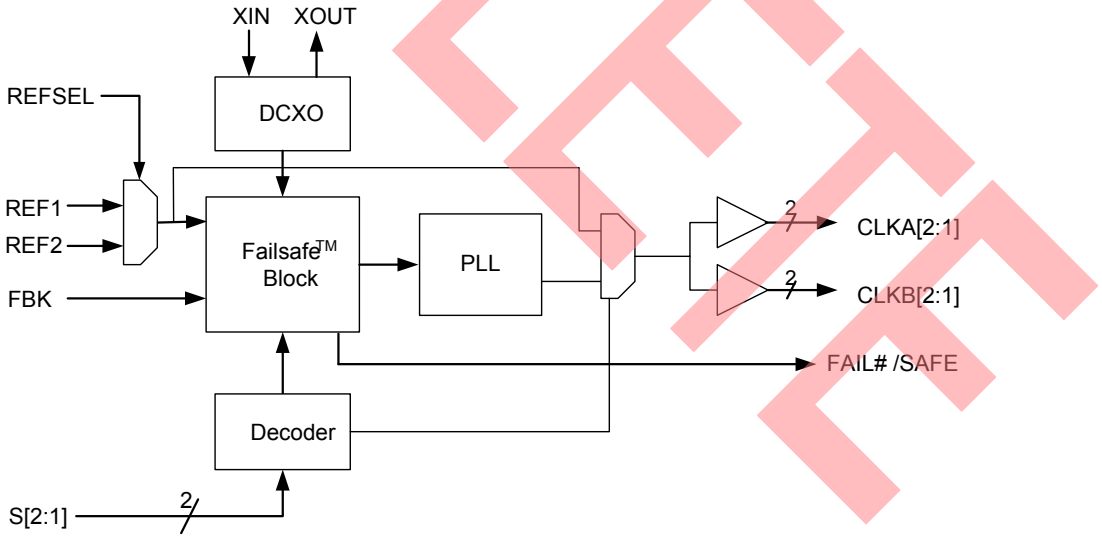
The CY23FS04-3 is a FailSafe™ zero delay buffer with two reference clock inputs and four phase-aligned outputs. The device provides an optimum solution for applications where continuous operation is required in the event of a primary clock failure.

The continuous, glitch-free operation is achieved by using a DCXO, which serves as a redundant clock source in the event of a reference clock failure by maintaining the last frequency and phase information of the reference clock.

The unique feature of the CY23FS04-3 is that the DCXO is in fact the primary clocking source, which is synchronized (phase-aligned) to the external reference clock. When this external clock is restored, the DCXO automatically resynchronizes to the external clock.

The frequency of the crystal that is connected to the DCXO must be an integer factor of the frequency of the reference clock. This factor is set by two select lines: S[2:1], see Configuration Table on page 3. The output power supply V_{DD} can be connected to either 2.5 V or 3.3 V. VDDC is the power supply pin for internal circuits and must be connected to 3.3 V.

Logic Block Diagram



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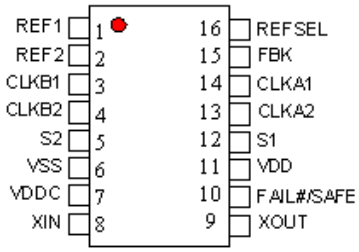
Pin Configurations

Figure 1. 16-pin TSSOP pinout



Pin Definitions

Pin No.	Pin Name	Description
1, 2	REF[2:1]	Reference clock inputs. 5V-tolerant. [1]
3, 4	CLKB[2:1]	Bank B clock outputs. [2, 3]
13, 14	CLKA[2:1]	Bank A clock outputs. [2, 3]
15	FBK	Feedback input to the PLL.[1, 2]
5, 12	S[2:1]	Frequency select pins and PLL and DCXO bypass mode. [4]
8	XIN	Reference crystal input.
9	XOUT	Reference crystal output.
10	FAIL#/SAFE	Valid reference indicator. A high level indicates a valid reference input.
11	VDD	2.5-V or 3.3-V power supply.
7	VDDC	3.3-V power supply.
6	VSS	Ground.
16	REFSEL	Reference select. Selects the active reference clock from either REF1 or REF2. REFSEL = 1, REF1 is selected; REFSEL = 0, REF2 is selected.

Configuration Table

S[2:1]	XTAL (MHz)		REF (MHz)		OUT (MHz)		REF:OUT Ratio	REF:XTAL Ratio	Out:XTAL Ratio
	Min	Max	Min	Max	Min	Max			
00			PLL and DCXO Bypass Mode						
01	8.33	30.00	4.17	15.00	4.17	15.00	×1	1/2	1/2
10	8.00	25.00	16.00	50.00	16.00	50.00	×1	2	2
11	8.33	27.78	50.00	166.70	50.00	166.70	×1	6	6

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Notes
1. Weak pull down on these inputs.
2. For normal operation, connect either one of the four clock outputs to the FBK input.
3. Weak pull downs on all outputs.
4. Weak pull ups on these inputs.

FailSafe Function

The CY23FS04-3 is targeted at clock distribution applications that require continued operation should the main reference clock fail. Existing approaches to this requirement have used multiple reference clocks with either internal or external methods for switching between references. The problem with this technique is that it leads to interruptions (or glitches) when transitioning from one reference to another, often requiring complex external circuitry or software to maintain system stability. The technique implemented in this design completely eliminates any switching of references to the PLL, greatly simplifying system design.

The CY23FS04-3 PLL is driven by the crystal oscillator, which is phase-aligned to an external reference clock so that the output of the device is effectively phase-aligned to the reference via the external feedback loop. This is accomplished by using a digitally controlled capacitor array to pull the crystal frequency over an approximate range of ±300 ppm from its nominal frequency.

In this mode, if the reference frequency fails (stop or disappear), the DCXO maintains its last setting and a flag signal (FAIL#/SAFE) is set to indicate failure of the reference clock.

The CY23FS04-3 provides two select bits, S1 and S2, to control the reference-to-crystal frequency ratio. The DCXO is internally tuned to the phase and frequency of the external reference only when the reference frequency divided by this ratio is within the DCXO capture range. If the frequency is out of range, a flag is set on the FAIL#/SAFE pin notifying the system that the selected reference is not valid. If the reference moves in range, then the flag is cleared, indicating to the system that the selected reference is valid.

Figure 2. Fail#/Safe Timing for Input Reference Failing Catastrophically

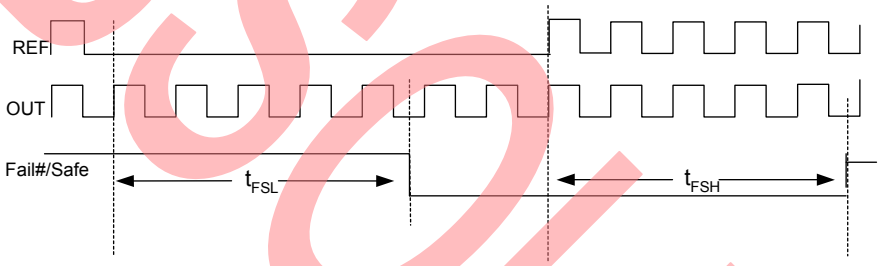

Figure 3. Fail#/Safe Timing Formula

$$t_{FSL(max)} = 2 (t_{REF} \times n) + 25ns$$

$$n = \frac{F_{REF}}{F_{XTAL}} = 4 \text{ (in above example)}$$

$$t_{FSH(min)} = 12 (t_{REF} \times n) + 25ns$$

Table 1. FailSafe Timing Table

Parameter	Description	Conditions	Min	Max	Unit
t_{FSL}	Fail#/Safe Assert Delay	Measured at 80% to 20%, Load = 15 pF	–	See Figure 3	ns
t_{FSH}	Fail#/Safe Deassert Delay	Measured at 80% to 20%, Load = 15 pF	See Figure 3	–	ns

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Figure 4. FailSafe Timing Diagram: Input Reference Slowly Drifting Out of FailSafe Capture Range

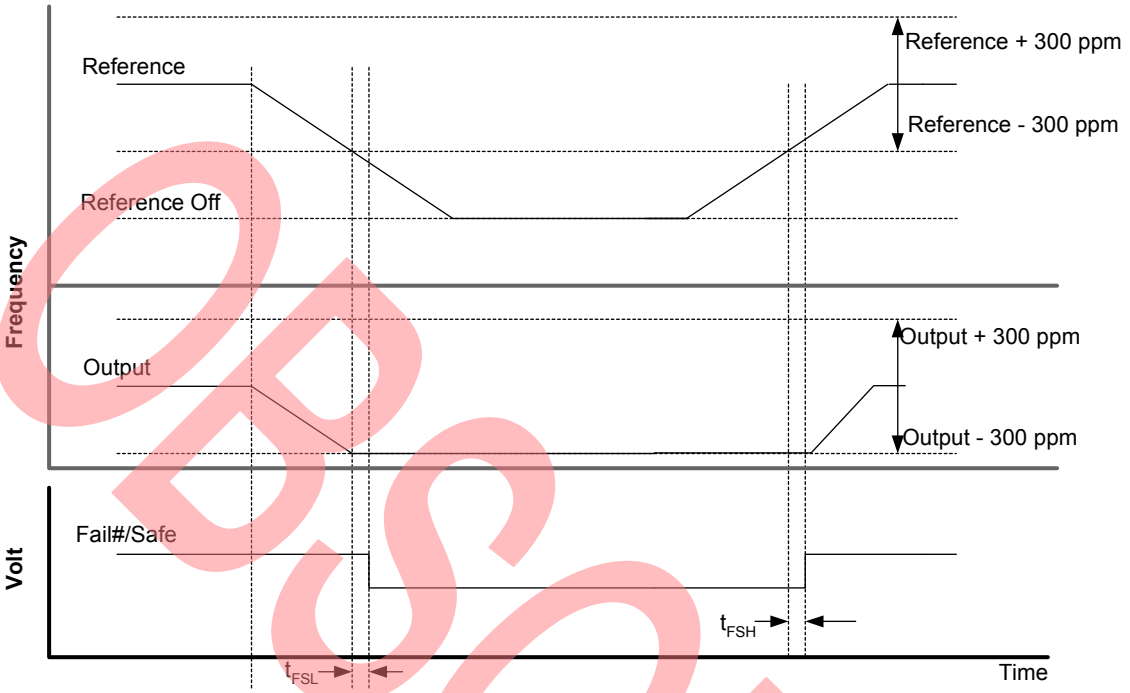
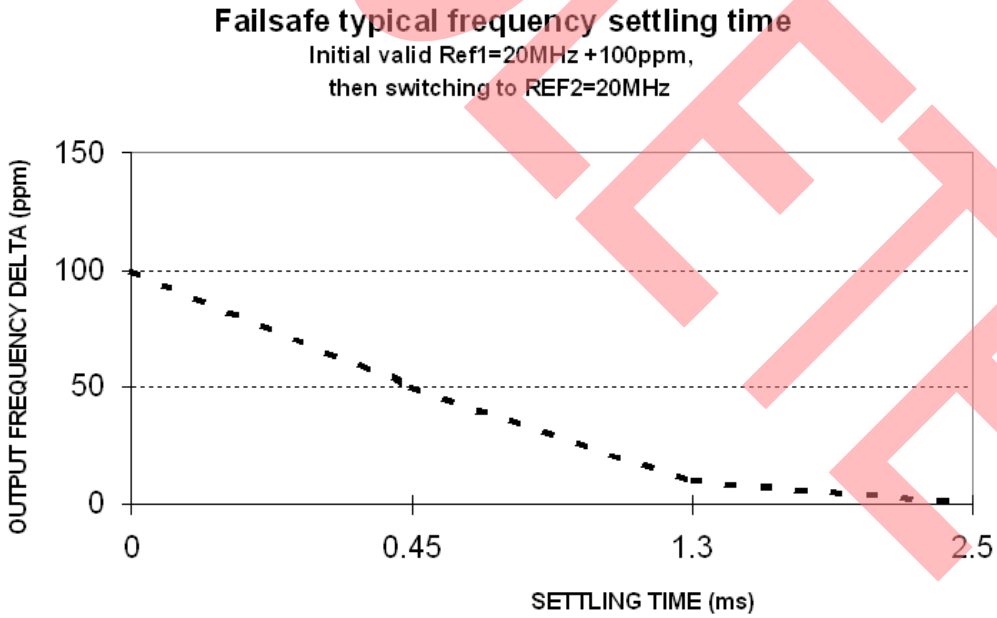


Figure 5. FailSafe Reference Switching Behavior



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Because of the DCXO architecture, the CY23FS04-3 has a much lower bandwidth than a typical PLL-based clock generator. This is shown in Figure 6. This low bandwidth makes the CY23FS04-3 also useful as a jitter attenuator. The loop bandwidth curve is also known as the jitter transfer curve.

Figure 6. FailSafe Effective Loop Bandwidth (min)

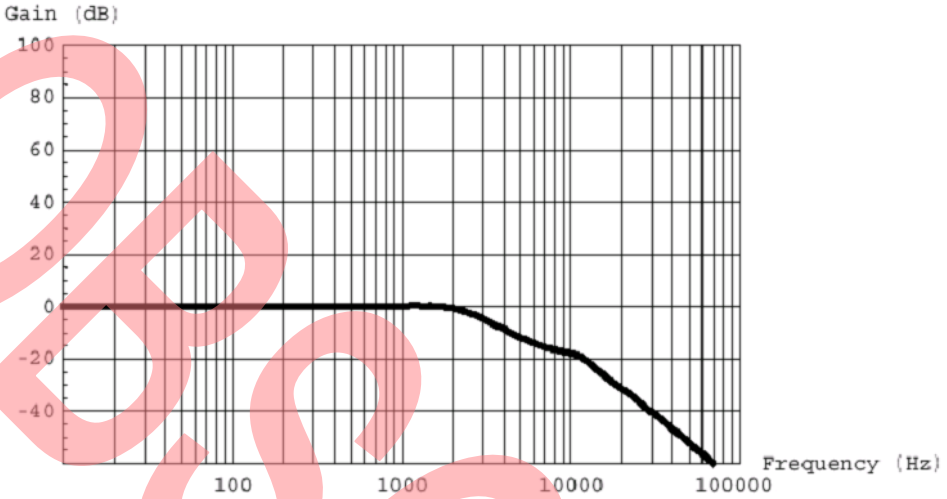

Figure 7. Duty Cycle

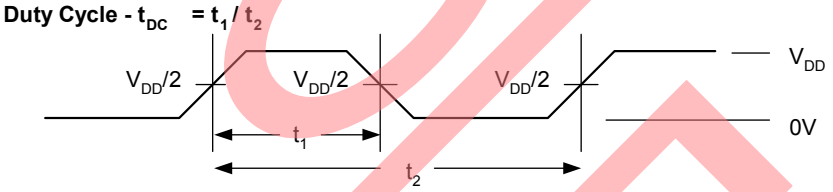

Figure 8. Input Slew Rate

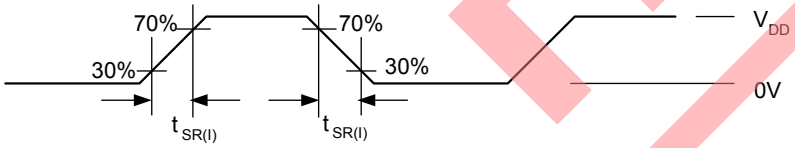

Figure 9. Output Slew Rate

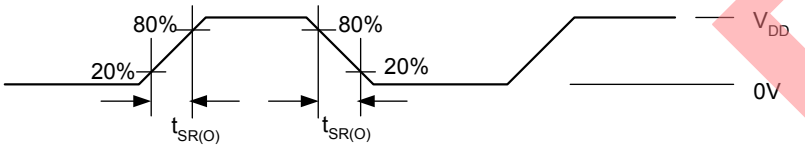

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Figure 10. Output to Output Skew and Intrabank Skew

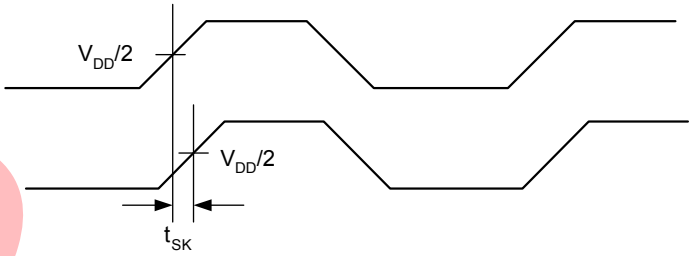


Figure 11. Part to Part Skew

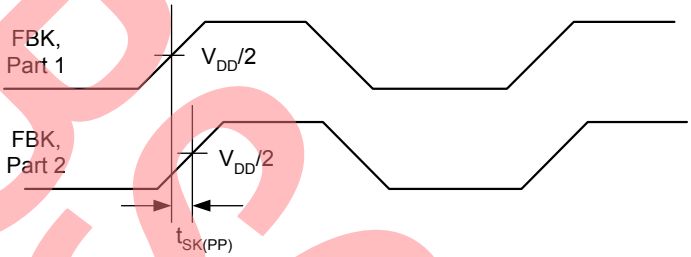
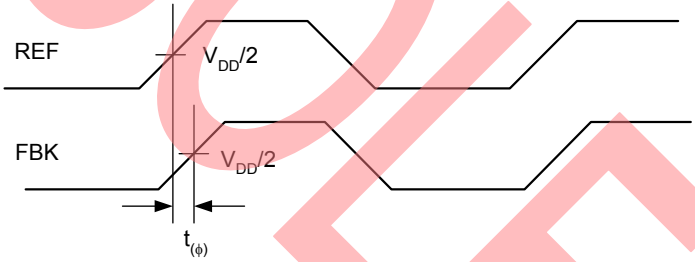


Figure 12. Phase Offset



XTAL Selection Criteria and Application Example

Choosing the appropriate XTAL ensures the FailSafe device is able to span an appropriate frequency of operation. Also, the XTAL parameters determine the holdover frequency stability. Critical parameters are given here. Cypress recommends that you choose:

- Low C0/C1 ratio (240 or less) so that the XTAL has enough range of pullability
- Low temperature frequency variation
- Low manufacturing frequency tolerance
- Low aging

C0 is the XTAL shunt capacitance (3 pF–7 pF typ).

C1 is the XTAL motional capacitance (10 fF–30 fF typ).

The capacitive load as “seen” by the XTAL is across its terminals. It is named $C_{LOADMIN}$ (for minimum value), and $C_{LOADMAX}$ (for maximum value).These are used to calculate the pull range.

Note that the C_{LOAD} range “center” is approximately 20 pF, but you may not want a XTAL calibrated to that load. This is because the pullability is not linear, as represented in the equation above. Plotting the pullability of the XTAL shows this expected behavior as shown in Figure 13. In this example, specifying a XTAL calibrated to 14 pF load provides a balanced ppm pullability range around the nominal frequency.

Example:

$C_{LOADMIN}$ = (12 pF IC input cap + 0 pF pulling cap + 6 pF trace cap on board) / 2 = 9 pF

$C_{LOADMAX}$ = (12 pF IC input cap + 48 pF pulling cap + 6 pF trace cap on board) / 2 = 33 pF

Pull Range = ($fC_{LOADMIN}$ – $fC_{LOADMAX}$) / $fC_{LOADMIN}$ = (C1 / 2) * [(1 / (C0 + $C_{LOADMIN}$)) – (1 / (C0 + $C_{LOADMAX}$))]

Pull Range in ppm = (C1 / 2) * [(1 / (C0 + $C_{LOADMIN}$)) – (1 / (C0 + $C_{LOADMAX}$))] * 10^6

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Figure 13. Frequency vs. C_{LOAD} Behavior for Example XTAL

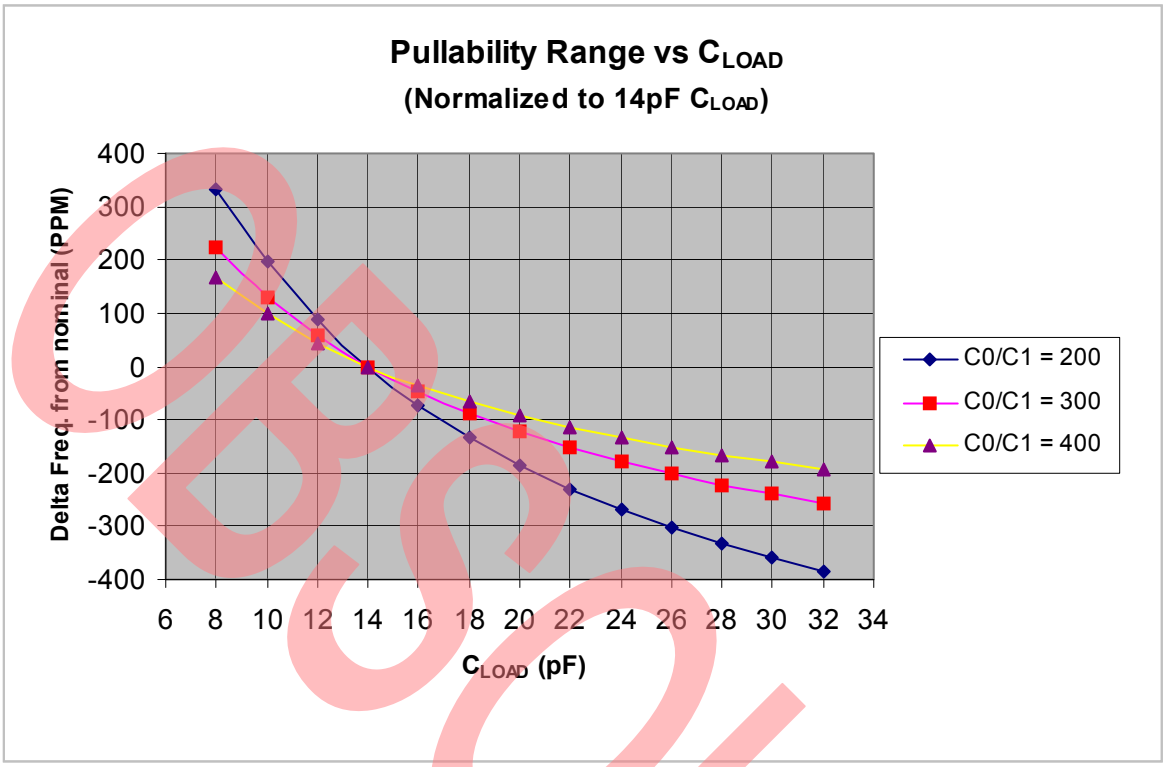

Table 2. Pullability Range of XTAL with Different C0/C1 Ratio

C0/C1 Ratio	C_{LOAD}(min)	C_{LOAD}(max)	Pullability Range	
200	8.0	32.0	–385	333
300	8.0	32.0	–256	222
400	8.0	32.0	–192	166

Calculated value of the pullability range for the XTAL with C0/C1 ratio of 200, 300, and 400 are shown in Table 2. For this calculation C_{LOAD}(min) = 8 pF and C_{LOAD}(max)= 32 pF is used. Using a XTAL that has a nominal frequency specified at load capacitance of 14 pF, almost symmetrical pullability range is obtained.

Next, it is important to calculate the pullability range including error tolerances. This is the capture range of the input reference frequency that the FailSafe device and XTAL combination can reliably span.

Calculating the capture range involves subtracting error tolerances as follows:

Parameter .....f error (ppm)

Manufacturing frequency tolerance 15

Temperature stability 30

Aging 3

Board/trace variation 5

Total 53

Example: Capture Range for XTAL with C0/C1 Ratio of 200

Negative Capture Range = –385 ppm + 53 ppm = –332 ppm

Positive Capture Range = 333 ppm – 53 ppm = +280 ppm

It is important to note that the XTAL with lower C0/C1 ratio has wider pullability/capture range as compared to the higher C0/C1 ratio. This helps to select the appropriate XTAL for use in the FailSafe application.

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Absolute Maximum Conditions

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Parameter	Description	Condition	Min	Max	Unit
V_{DD}	Supply voltage		–0.5	4.6	V
V_{IN}	Input voltage	Relative to V_{SS}	–0.5	V_{DD} + 0.5	VDC
T_S	Temperature, Storage	Non Functional	–65	150	°C
T_J	Temperature, Junction	Functional	–	125	°C
ESD_{HBM}	ESD protection (human body model)	MIL-STD-883, Method 3015	2000	–	V
$Ø_{JC}$	Dissipation, junction to case	Mil-Spec 883E Method 1012.1	30		°C/W
$Ø_{JA}$	Dissipation, junction to ambient	JEDEC (JESD 51)	102		°C/W
UL–94	Flammability rating	At 1/8 in.	V–0		
MSL	Moisture sensitivity level		3		
Multiple Supplies: The voltage on any input or I/O pin cannot exceed the power pin during power up. Power supply sequencing is NOT required.					

Recommended Pullable Crystal Specifications

Parameter [5]	Name	Comments	Min	Typ	Max	Unit
F_{NOM}	Nominal crystal frequency	Parallel resonance, fundamental mode, AT cut	8.00	–	30.00	MHz
$C_{LOADNOM}$	Nominal load capacitance		–	14	–	pF
R_1	Equivalent series resistance (ESR)	Fundamental mode	–	–	25	Ω
R_3/R_1	Ratio of third overtone mode ESR to fundamental mode ESR	Ratio used because typical R_1 values are much less than the maximum spec	3	–	–	
DL	Crystal drive level	No external series resistor assumed	–	0.5	2	mW
F_{3SEPLI}	Third overtone separation from 3 × F_{NOM}	High side	300	–	–	ppm
F_{3SEPLO}	Third overtone separation from 3 × F_{NOM}	Low side	–	–	–150	ppm
C0	Crystal shunt capacitance		–	–	7	pF
C0 / C1	Ratio of shunt to motional capacitance		180	–	250	
C1	Crystal motional capacitance		14.4	18	21.6	fF

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Note

5. Ecliptek ECX-5788-13.500M, ECX-5807-19.440M, ECX-5872-19.53125M, ECX-6362-18.432M, ECX-5808-27.000M, ECX-5884-17.664M, ECX-5883-16.384M, ECX-5882-19.200M, ECX-5880-24.576M meet these specifications.

Operating Conditions

For FailSafe Devices

Parameter	Description	Min	Max	Unit
V_{DDC}	3.3-V supply voltage	3.135	3.465	V
V_{DD}	2.5-V supply voltage range	2.375	2.625	V
	3.3-V supply voltage range	3.135	3.465	V
T_A	Ambient operating temperature, Industrial	–40	85	°C
C_L	Output load capacitance (Fout ≤ 100 MHz)	–	30	pF
	Output load capacitance (Fout > 100 MHz)	–	15	pF
C_{IN}	Input capacitance (except XIN)	–	7	pF
C_{XIN}	Crystal input capacitance (all internal caps off)	10	13	pF
T_{PU}	Power-up time for all V_{DD}s to reach minimum specified voltage (power ramps must be monotonic)	0.05	500	ms

Electrical Characteristics

For FailSafe Devices

Parameter	Description	Test Conditions	Min	Typ	Max	Unit
V_{IL}	Input low voltage	CMOS Levels, 30% of V_{DD}	–	–	0.3 × V_{DD}	V
V_{IH}	Input high voltage	CMOS Levels, 70% of V_{DD}	0.7 × V_{DD}	–	–	V
I_{IL}	Input low current	V_{IN} = V_{SS} (100k pull up only)	–	–	50	µA
I_{IH}	Input high current	V_{IN} = V_{DD} (100k pull down only)	–	–	50	µA
I_{OL}	Output low current	V_{OL} = 0.5 V, V_{DD} = 2.5 V	–	18	–	mA
		V_{OL} = 0.5 V, V_{DD} = 3.3 V	–	20	–	mA
I_{OH}	Output high current	V_{OH} = V_{DD} – 0.5 V, V_{DD} = 2.5 V	–	18	–	mA
		V_{OH} = V_{DD} – 0.5 V, V_{DD} = 3.3 V	–	20	–	mA
I_{DDQ}	Quiescent current	All inputs grounded, PLL and DCXO in bypass mode, Reference Input = 0	–	–	250	µA

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Switching Characteristics

For FailSafe Devices

Parameter [6]	Description	Test Conditions	Min	Max	Unit
f_{REF}	Reference frequency	Industrial Grade	4.17	166.7	MHz
f_{OUT}	Output frequency	15 pF Load, Industrial Grade	4.17	166.7	MHz
f_{XIN}	DCXO frequency		8.0	30	MHz
t_{DC}	Duty cycle	Measured at $V_{DD}/2$	47	53	%
$t_{SR(I)}$	Input slew rate	Measured on REF1 Input, 30% to 70% of V_{DD}	0.5	4.0	V/ns
$t_{SR(O)}$	Output slew rate	Measured from 20% to 80% of V_{DD} = 3.3 V, 15 pF Load	0.8	4.0	V/ns
		Measured from 20% to 80% of V_{DD} = 2.5 V, 15 pF Load	0.4	3.0	V/ns
$t_{SK(O)}$	Output-to-output skew	All outputs equally loaded, measured at $V_{DD}/2$	–	200	ps
$t_{SK(PP)}$	Part-to-part skew	Measured at $V_{DD}/2$	–	500	ps
$t_{(\phi)}$ [7]	Static phase offset	Measured at $V_{DD}/2$	–	250	ps
$t_{D(\phi)}$ [7]	Dynamic phase offset	Measured at $V_{DD}/2$	–	500	ps
$t_{J(CC)}$	Cycle-to-cycle jitter	Load = 15 pF, $f_{OUT} \geq 6.25$ MHz	–	200	ps
			–	35	ps_{RMS}
t_{LOCK}	Lock time (Stable power supply and valid clock at REF)	$f_{OUT} < 30$ MHz	–	400	ms
		30 MHz $\leq f_{OUT} \leq$ 100 MHz	–	200	ms
		$f_{OUT} > 100$ MHz	–	150	ms

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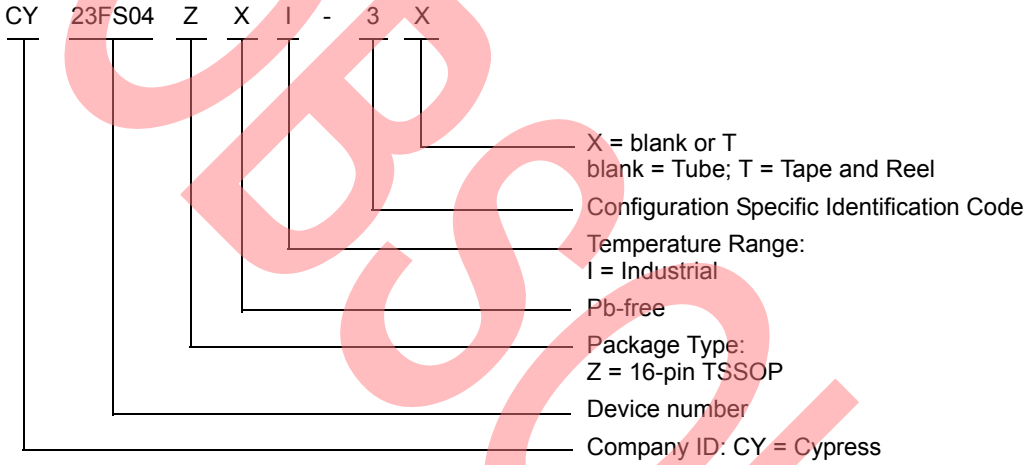
Notes

6. Parameters guaranteed by design and characterization, not 100% tested in production.
7. The $t_{(\phi)}$ reference feedback input delay is guaranteed for a maximum 4:1 input edge ratio between the two signals as long as $t_{SR(I)}$ is maintained. Static phase offset excludes jitter; dynamic phase offset includes jitter.

Ordering Information

Part Number	Package Type	Product Flow
Pb-free		
CY23FS04ZXI-3	16-pin TSSOP	Industrial, –40 °C to 85 °C
CY23FS04ZXI-3T	16-pin TSSOP – Tape and Reel	Industrial, –40 °C to 85 °C

Ordering Code Definitions



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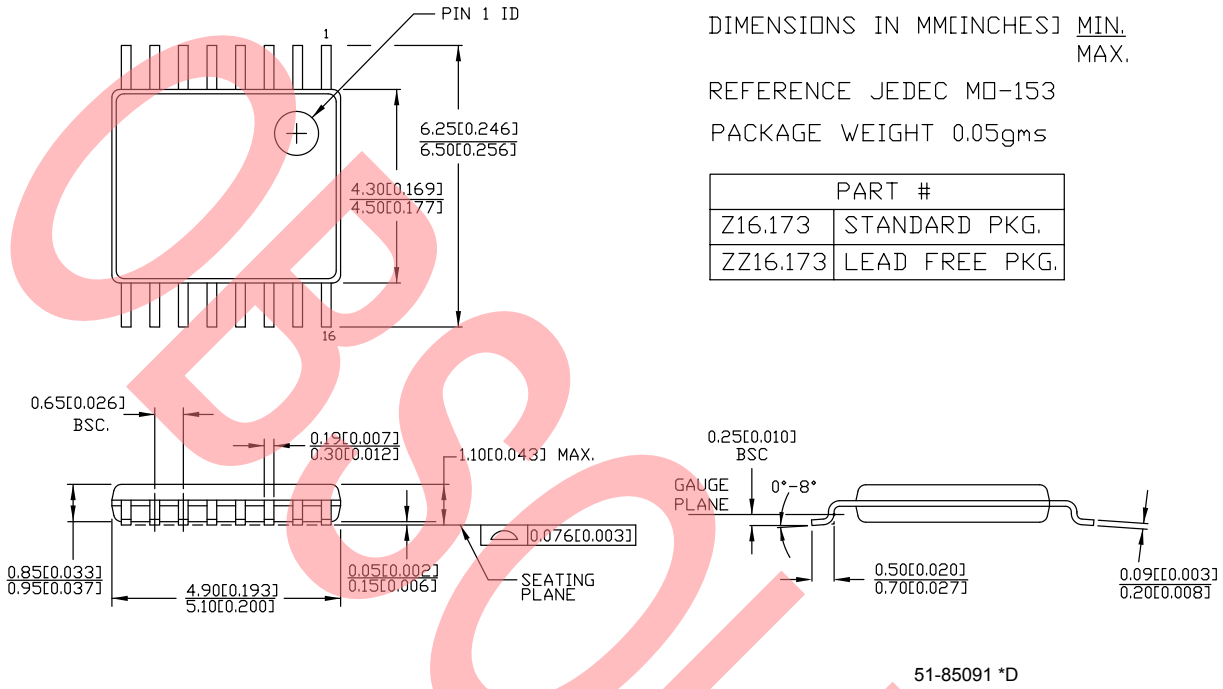
Package Diagram

Figure 14. 16-pin TSSOP (4.40 mm Body) Z16.173/ZZ16.173 Package Outline, 51-85091



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Acronyms

Acronym	Description
DCXO	digitally controlled crystal oscillator
ESD	electrostatic discharge
PLL	phase locked loop
RMS	root mean square
SSOP	shrunk small outline package
XTAL	crystal

Document Conventions

Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
µA	microampere
mA	milliampere
ms	millisecond
MHz	megahertz
ns	nanosecond
pF	picofarad
ps	picosecond
V	volt

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Document History Page

Document Title: CY23FS04-3, Failsafe™ 2.5 V/3.3 V Zero Delay Buffer Document Number: 001-59002				
Rev.	**ECN No.**	**Submission Date**	**Orig. of Change**	**Description of Change**
**	2865337	01/25/2010	CXQ	New spec release.
*A	2925613	04/30/10	KVM	Posting to external web.
*B	3054919	10/11/2010	KVM	Updated Switching Characteristics: Changed maximum value of $t_{D(\phi)}$ parameter from 200 ps to 500 ps. Updated Note 7 (Added phase offset definition). Added Ordering Code Definitions. Updated Package Diagram. Added Acronyms, and Units of Measure.
*C	3898322	02/09/2013	CINM	Updated Absolute Maximum Conditions: Changed value of $Ø_{JC}$ from 29.87 °C/W to 30 °C/W. Changed value of $Ø_{JA}$ from 120.11 °C/W. to 102 °C/W. Updated Package Diagram: spec 51-85091 – Changed revision from *C to *D.
*D	4588547	12/05/2014	AJU	Obsoleting document.

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PSoC	cypress.com/go/psoc
Touch Sensing	cypress.com/go/touch
USB Controllers	cypress.com/go/USB
Wireless/RF	cypress.com/go/wireless

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